

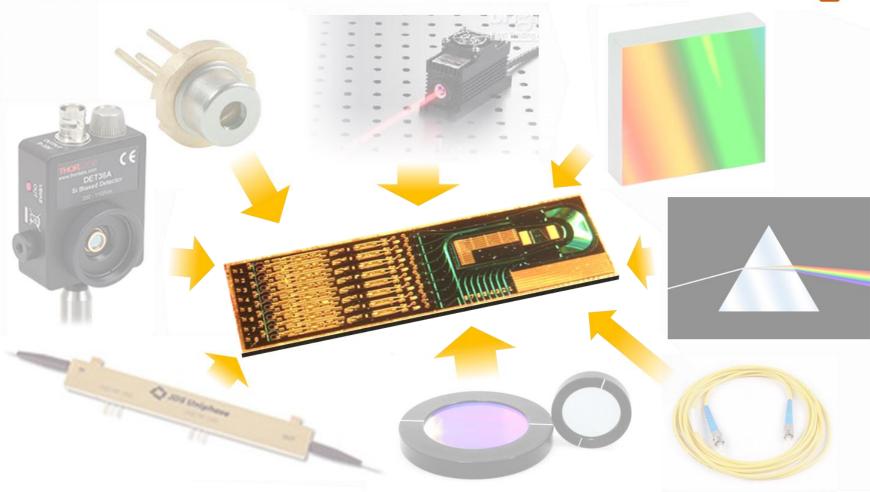
Indium-Phosphide Pilot Line for up-scaled, low-barrier, self-sustained, PIC ecosystem





Photonic integration – optical chips





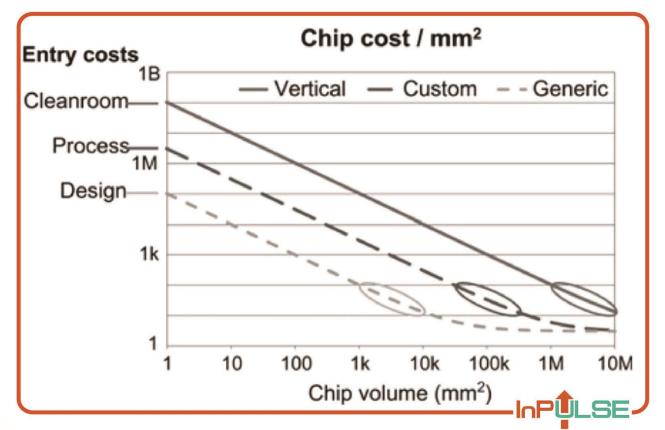




Value proposition



InPulse **enables** fabless businesses to transition from first concept experimentation to **industrial prototype and pre-production** with shared technology investments







From prototype to pilot production



Idea Research Prototyping Piloting Manufacturing

TRL1 TRL2 TRL3 TRL4 TRL5 TRL6 TRL7 TRL8 TRL9









Integrating the Photonic Ecosystem







DESIGN FOUNDRIES PACKAGING TEST RELIABILITY





InPulse in a nutshell



- 1. Create manufacturing process design kits by using smart testing to efficiently collect manufacturing statistics
- 2. Increase capacity for open access industrial prototyping and systematically improve performance of the building blocks
- 3. Validate the pilot line with two experienced Participants to validate and stretch the platform **performance beyond state of the art**
- 4. Demonstration through tens of external user designs
- 5. Establish a **sustainable business model** with a resilient industrial ecosystem to ensure continued open-access after four years
- 6. Support businesses as they scale to volume production

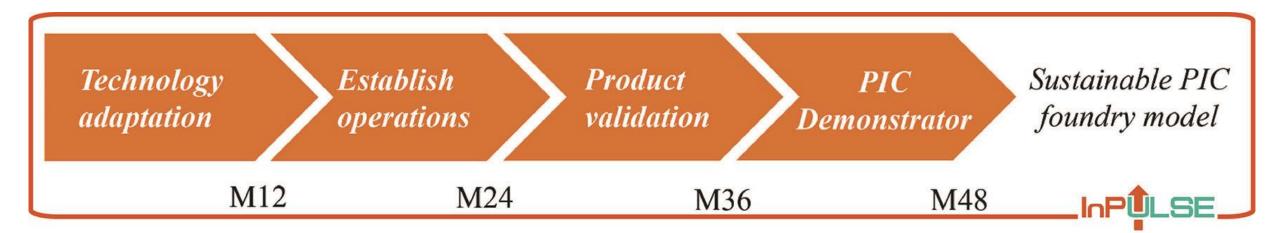




InPulse Project Phasing



2019 2020 2021 2022 2023



Stabilising and optimising processes

Manufacturing PDKs developed

Two validation circuits taken to TRL7

New demonstrator circuits in development

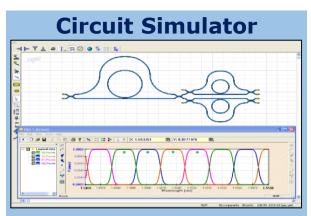


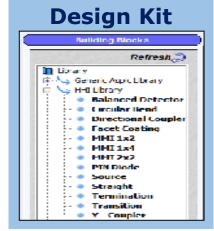


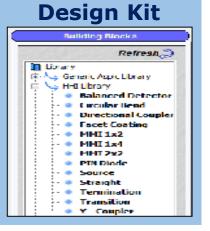


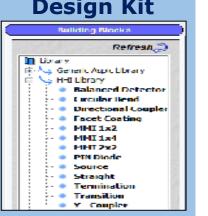
Design automation







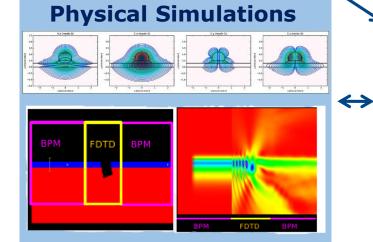


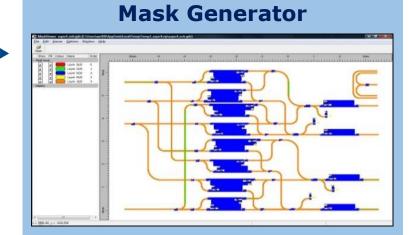




Foundry







Faster and fewer design cycles

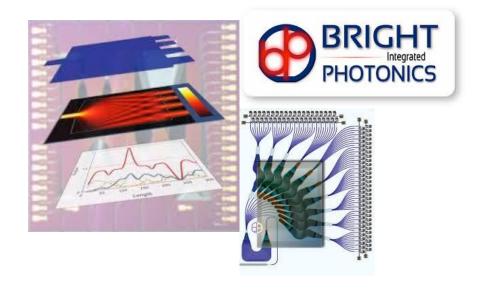


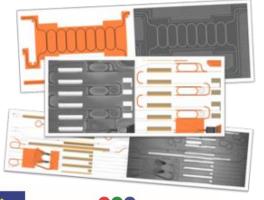


PHOTONICS PUBLIC PRIVATE PARTNERSHIP



IP development











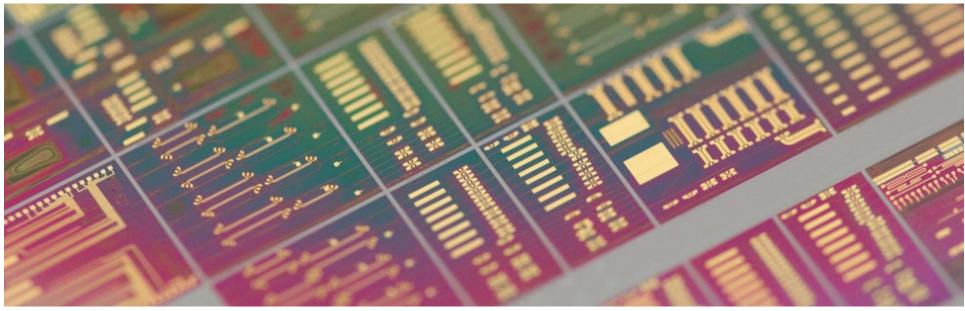
Commercial Design houses:

- Photonic IC
- Building Blocks for PIC designers
- PDKS for foundries
- Generate IP on top of generic technologies
- shorten concept to prototype time



Scaling production





- Three complementary InP PIC fabs for second sourcing
- Reduced time in fab
- Higher frequency wafer starts
- Higher predictability, high performance metrics

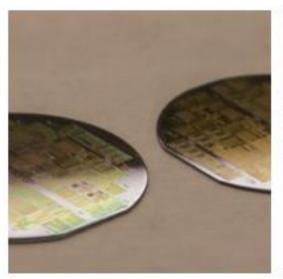


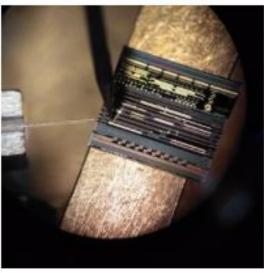


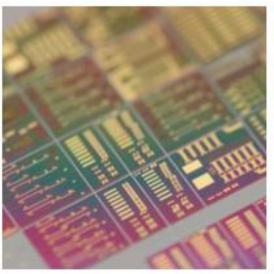


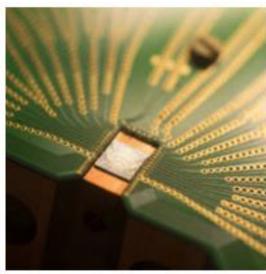
Measurement automation











- High throughput test to create manufacturing grade PDKs
- Tight coupling to design tools through standardised building blocks
- Test-as-a-service offer for lab-less designers



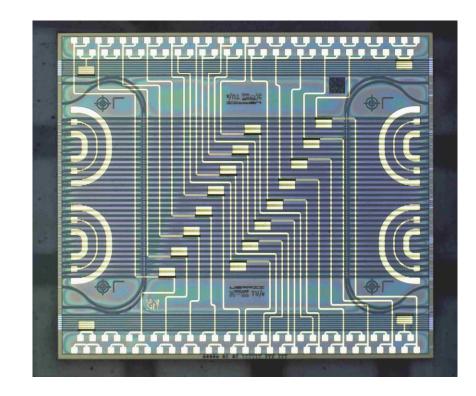


Packaging and systems integration



Reference designs to couple

- PICs to package
- Test to design
- Measurement to process centering











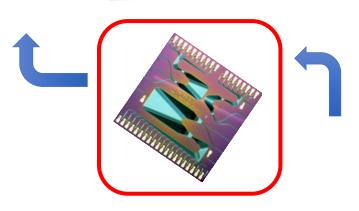






PICs in space – fiber sensors structural health, interferometric





	low	CIV	$I \cap D$
•	IC) VV	. J V I	IdP

- low cost
- hybrid integration of optics and electronics
- improved thermal and vibration stability
- improved reliability

	Co-60 (1MeV γ)	Proton (MeV)
Max rate	23 Gy/hr	10 ⁹ p/cm ² /s
Max dose	1100 Gy	10 ¹² p/cm ²

- SOA led 20-30% attenuation (acceptable)
- AWG phase shift and attenuation below measurement uncertainty



ESTEC test facility Co-60: alignment of dies and package for live-monitoring during irradiation









ficontec





























Making PICs easy!

www.inpulse.jeppix.eu coordinator@jeppix.eu











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